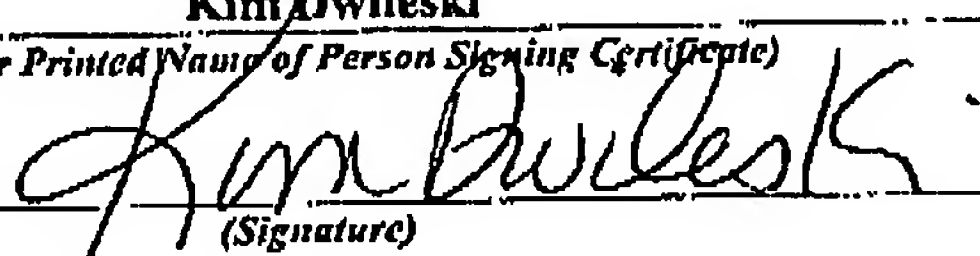


<b>CERTIFICATE OF TRANSMISSION BY FACSIMILE (37 CFR 1.8)</b>			<b>Docket No.</b> BUR920030026US1
Applicant(s): Gardecki et al.			
<b>Application No.</b> 10/604,164	<b>Filing Date</b> 6/28/2003	<b>Examiner</b> Brook Kebede	<b>Group Art Unit</b> 2823
<b>Invention:</b> METHOD FOR FORMING INTERCONNECTS ON THIN WAFERS			
<b>RECEIVED</b> <b>CENTRAL FAX CENTER</b> MAY 31 2005			
<p>I hereby certify that this <u>Request for Reconsideration (7 pages)</u> (Identify type of correspondence)</p> <p>is being facsimile transmitted to the United States Patent and Trademark Office (Fax. No. <u>703-872-9306</u>)</p> <p>on <u>5/31/2005</u> (Date)</p> <p style="text-align: right;"><u>Kim Dwileski</u> (Typed or Printed Name of Person Signing Certificate)  (Signature)</p> <p style="text-align: center;">Note: Each paper must have its own certificate of mailing.</p>			

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Appl. No.: 10/604,164

Applicant(s): Gardocki et al.

Filed.: June 28, 2003

Art Unit: 2823

Dkt. No.: BUR920030026US1

Examiner: Brook Kebede

Title: **METHOD FOR FORMING INTERCONNECTS ON THIN WAFERS**

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Honorable Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

**REQUEST FOR RECONSIDERATION**

This Request for Reconsideration is being filed in response to the Office Action mailed on May 17, 2005. Applicants request this Amendment be entered in the above-identified application and reconsideration of the application in view of the Amendments and Remarks that follow.

BUR9-2003-0026-US1